

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7287940

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
GIRISH RAMESH CHANDANKAR	04/19/2022
HARI KRISHNAN ELUMALAI	04/19/2022
PANKAJ GUPTA	04/19/2022
RAJESH CHAKRAVARTY	04/19/2022
AKASH AGRAWAL	04/19/2022
RAUNAQ PANDYA	04/19/2022
YAGANTI SASIDHAR REDDY	04/19/2022
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17724534
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ATTORNEY DOCKET NUMBER:	IIP-HCL-P0106-US
NAME OF SUBMITTER:	KENDAL M. SHEETS
SIGNATURE:	/Kendal M. Sheets/
DATE SIGNED:	04/20/2022

Total Attachments: 3

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ASSIGNMENT

WHEREAS I, the below named inventor, [hereinafter referred to as **Assignor**], have made an invention entitled:

METHOD AND SYSTEM FOR CLASSIFYING FACES OF BOUNDARY REPRESENTATION (B-REP) MODELS USING ARTIFICIAL INTELLIGENCE

for which I executed an application for United States Letters Patent concurrently herewith; and

WHEREAS **HCL Technologies Limited**, whose post office address is **806, Siddharth, 96, Nehru Place, New Delhi - 110019, India** (hereinafter referred to as **Assignee**), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of good and valuable consideration the receipt of which from Assignee is hereby acknowledged, I, as assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, MY entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;


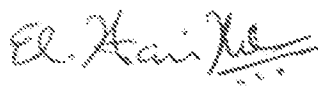

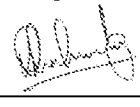

AND, I HEREBY covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment;

AND, I HEREBY further covenant and agree that I will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

ASSIGNMENT

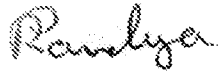
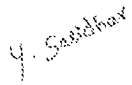
ATTORNEY REF. NO.: IIP-HCL-P0106-US

IN TESTIMONY WHEREOF, I have here into set my hand.

<u>Full Name of First Assignor</u> <u>Girish Ramesh Chandankar</u>	<u>Assignor's Signature</u> 	<u>Date</u> 19.04.2021
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<u>Full Name of Fifth Assignor</u> <u>Akash Agrawal</u>	<u>Assignor's Signature</u> 	<u>Date</u> 19.04.2021
<u>Address: HCL Technologies Ltd. Rajiv Gandhi IT Park, MIDC, Phase 1, Hinjawadi, Pune - 411057</u>		<u>Citizenship</u> IN

ASSIGNMENT

ATTORNEY REF. NO.: IIP-HCL-P0106-US

<u>Full Name of Sixth Assignor</u> Raunaq Pandya	<u>Assignor's Signature</u> 	<u>Date</u> 19.04.2021
<u>Address:</u> HCL, 7th floor, B Wing Reliable Tech Park, 703-A, Airoli Navi Mumbai, 400708		<u>Citizenship</u> IN
<u>Full Name of Seventh Assignor</u> Yaganti Sasidhar Reddy	<u>Assignor's Signature</u> 	<u>Date</u> 19.04.2021
<u>Address:</u> HCL, 7th floor, B Wing Reliable Tech Park, 703-A, Airoli Navi Mumbai, 400708		<u>Citizenship</u> IN
NAMES OF ADDITIONAL INVENTORS ATTACHED <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO		

SHEETS LAW

PATENT

RECORDED: 04/20/2022

REEL: 059645 FRAME: 0550